

L Numb r	Hits	Search Text	DB	Time stamp
38	41	(US-5519176-\$ or US-5384486-\$ or US-5402318-\$ r US-5396397-\$ or US-5272600-\$ or US-5287072-\$ r US-5177670-\$ r US-5354599-\$ or US-5025233-\$ or US-5027253-\$ or US-4866507-\$ or US-4801996-\$ or US-4739448-\$ or US-4371851-\$ or US-4342013-\$ or US-4153988-\$ or US-6411181-\$ or US-5668509-\$ or US-5675302-\$ or US-6362525-\$ or US-6023211-\$ or US-4954929-\$ or US-6272003-\$ or US-6121854-\$ or US-6194979-\$ or US-6102710-\$).did. or (US-6097097-\$ or US-6023408-\$ or US-6087885-\$ or US-6075211-\$ or US-5978231-\$ or US-5854534-\$ or US-5955752-\$).did. or (US-20020113673-\$ or US-20010010207-\$ or US-20020118075-\$ or US-20020027763-\$ or US-20020101382-\$ or US-20010017556-\$ or US-20010013075-\$ or US-20020020917-\$).did.	USPAT; US-PGPUB	2002/09/27 14:07
39	9	((US-5519176-\$ or US-5384486-\$ or US-5402318-\$ or US-5396397-\$ or US-5272600-\$ or US-5287072-\$ or US-5177670-\$ or US-5354599-\$ or US-5025233-\$ or US-5027253-\$ or US-4866507-\$ or US-4801996-\$ or US-4739448-\$ or US-4371851-\$ or US-4342013-\$ or US-4153988-\$ or US-6411181-\$ or US-5668509-\$ or US-5675302-\$ or US-6362525-\$ or US-6023211-\$ or US-4954929-\$ or US-6272003-\$ or US-6121854-\$ or US-6194979-\$ or US-6102710-\$).did. or (US-6097097-\$ or US-6023408-\$ or US-6087885-\$ or US-6075211-\$ or US-5978231-\$ or US-5854534-\$ or US-5955752-\$).did. or (US-20020113673-\$ or US-20010010207-\$ or US-20020118075-\$ or US-20020027763-\$ or US-20020101382-\$ or US-20010017556-\$ or US-20010013075-\$ or US-20020020917-\$).did.) and antenna	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/27 14:11

40	3	((US-5519176-\$ r US-5384486-\$ r US-5402318-\$ r US-5396397-\$ or US-5272600-\$ or US-5287072-\$ or US-5177670-\$ r US-5354599-\$ or US-5025233-\$ r US-5027253-\$ or US-4866507-\$ or US-4801996-\$ or US-4739448-\$ or US-4371851-\$ or US-4342013-\$ or US-4153988-\$ or US-6411181-\$ or US-5668509-\$ or US-5675302-\$ or US-6362525-\$ or US-6023211-\$ or US-4954929-\$ or US-6272003-\$ or US-6121854-\$ or US-6194979-\$ or US-6102710-\$).did. or (US-6097097-\$ or US-6023408-\$ or US-6087885-\$ or US-6075211-\$ or US-5978231-\$ or US-5854534-\$ or US-5955752-\$).did. or (US-20020113673-\$ or US-20010010207-\$ or US-20020118075-\$ or US-20020027763-\$ or US-20020101382-\$ or US-20010017556-\$ or US-20010013075-\$ or US-20020020917-\$).did.) and antenna) and shield	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/27 14:15
41	7	"5384486"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/27 14:16
42	41	"4739448"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/27 14:16
43	17	((US-5519176-\$ or US-5384486-\$ or US-5402318-\$ or US-5396397-\$ or US-5272600-\$ or US-5287072-\$ or US-5177670-\$ or US-5354599-\$ or US-5025233-\$ or US-5027253-\$ or US-4866507-\$ or US-4801996-\$ or US-4739448-\$ or US-4371851-\$ or US-4342013-\$ or US-4153988-\$ or US-6411181-\$ or US-5668509-\$ or US-5675302-\$ or US-6362525-\$ or US-6023211-\$ or US-4954929-\$ or US-6272003-\$ or US-6121854-\$ or US-6194979-\$ or US-6102710-\$).did. or (US-6097097-\$ or US-6023408-\$ or US-6087885-\$ or US-6075211-\$ or US-5978231-\$ or US-5854534-\$ or US-5955752-\$).did. r (US-20020113673-\$ r US-20010010207-\$ or US-20020118075-\$ or US-20020027763-\$ r US-20020101382-\$ r US-20010017556-\$ or US-20010013075-\$ r US-20020020917-\$).did.) and (shield or shielded or shielding)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/27 14:17

44	15	((US-5519176-\$ r US-5384486-\$ r US-5402318-\$ or US-5396397-\$ or US-5272600-\$ or US-5287072-\$ or US-5177670-\$ or US-5354599-\$ or US-5025233-\$ r US-5027253-\$ or US-4866507-\$ r US-4801996-\$ or US-4739448-\$ or US-4371851-\$ or US-4342013-\$ or US-4153988-\$ or US-6411181-\$ or US-5668509-\$ or US-5675302-\$ or US-6362525-\$ or US-6023211-\$ or US-4954929-\$ or US-6272003-\$ or US-6121854-\$ or US-6194979-\$ or US-6102710-\$).did. or (US-6097097-\$ or US-6023408-\$ or US-6087885-\$ or US-6075211-\$ or US-5978231-\$ or US-5854534-\$ or US-5955752-\$).did. or (US-20020113673-\$ or US-20010010207-\$ or US-20020118075-\$ or US-20020027763-\$ or US-20020101382-\$ or US-20010017556-\$ or US-20010013075-\$ or US-20020020917-\$).did.) and ((shield or shielded or shielding) near10 (plate or conductor or line))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/27 14:20
45	15	((US-5519176-\$ or US-5384486-\$ or US-5402318-\$ or US-5396397-\$ or US-5272600-\$ or US-5287072-\$ or US-5177670-\$ or US-5354599-\$ or US-5025233-\$ or US-5027253-\$ or US-4866507-\$ or US-4801996-\$ or US-4739448-\$ or US-4371851-\$ or US-4342013-\$ or US-4153988-\$ or US-6411181-\$ or US-5668509-\$ or US-5675302-\$ or US-6362525-\$ or US-6023211-\$ or US-4954929-\$ or US-6272003-\$ or US-6121854-\$ or US-6194979-\$ or US-6102710-\$).did. or (US-6097097-\$ or US-6023408-\$ or US-6087885-\$ or US-6075211-\$ or US-5978231-\$ or US-5854534-\$ or US-5955752-\$).did. or (US-20020113673-\$ or US-20010010207-\$ or US-20020118075-\$ or US-20020027763-\$ or US-20020101382-\$ or US-20010017556-\$ or US-20010013075-\$ or US-20020020917-\$).did.) and ((shield or shielded or shielding) near10 (plate or conductor or line))) and (hole or via or opening or throughhole or viahole or throughhole or through-hole or via-hole)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/27 14:22

46	4	<p>(((US-5519176-\$ r US-5384486-\$ or US-5402318-\$ r US-5396397-\$ r US-5272600-\$ or US-5287072-\$ r US-5177670-\$ or US-5354599-\$ or US-5025233-\$ or US-5027253-\$ r US-4866507-\$ or US-4801996-\$ r US-4739448-\$ or US-4371851-\$ or US-4342013-\$ or US-4153988-\$ or US-6411181-\$ or US-5668509-\$ or US-5675302-\$ or US-6362525-\$ or US-6023211-\$ or US-4954929-\$ or US-6272003-\$ or US-6121854-\$ or US-6194979-\$ or US-6102710-\$).did. or (US-6097097-\$ or US-6023408-\$ or US-6087885-\$ or US-6075211-\$ or US-5978231-\$ or US-5854534-\$ or US-5955752-\$).did. or (US-20020113673-\$ or US-20010010207-\$ or US-20020118075-\$ or US-20020027763-\$ or US-20020101382-\$ or US-20010017556-\$ or US-20010013075-\$ or US-20020020917-\$).did.) and ((shield or shielded or shielding) near10 (plate or conductor or line))) and (hole or via or opening or throughhole or viahole or throughhole or through-hole or via-hole)) and antenna</p>	<p>USPAT; US-PGPUB; EPO; JP ; DERWENT; IBM_TDB</p>	<p>2002/09/27 14:25</p>
47	3	<p>((((US-5519176-\$ or US-5384486-\$ or US-5402318-\$ or US-5396397-\$ or US-5272600-\$ or US-5287072-\$ or US-5177670-\$ or US-5354599-\$ or US-5025233-\$ or US-5027253-\$ or US-4866507-\$ or US-4801996-\$ or US-4739448-\$ or US-4371851-\$ or US-4342013-\$ or US-4153988-\$ or US-6411181-\$ or US-5668509-\$ or US-5675302-\$ or US-6362525-\$ or US-6023211-\$ or US-4954929-\$ or US-6272003-\$ or US-6121854-\$ or US-6194979-\$ or US-6102710-\$).did. or (US-6097097-\$ or US-6023408-\$ or US-6087885-\$ or US-6075211-\$ or US-5978231-\$ or US-5854534-\$ or US-5955752-\$).did. or (US-20020113673-\$ or US-20010010207-\$ or US-20020118075-\$ or US-20020027763-\$ or US-20020101382-\$ or US-20010017556-\$ or US-20010013075-\$ or US-20020020917-\$).did.) and ((shield or shielded or shielding) near10 (plate or conductor r line))) and (hol or via or opening or throughhol or viahole or thr ough le r through-hole r via-h le)) and antenna) and (wir r wireb nd r wire-bond or wire-b nding or pad)</p>	<p>USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB</p>	<p>2002/09/27 14:35</p>

48	1	((((US-5519176-\$ or US-5384486-\$ r US-5402318-\$ or US-5396397-\$ or US-5272600-\$ or US-5287072-\$ or US-5177670-\$ r US-5354599-\$ r US-5025233-\$ or US-5027253-\$ or US-4866507-\$ r US-4801996-\$ or US-4739448-\$ or US-4371851-\$ or US-4342013-\$ or US-4153988-\$ or US-6411181-\$ or US-5668509-\$ or US-5675302-\$ or US-6362525-\$ or US-6023211-\$ or US-4954929-\$ or US-6272003-\$ or US-6121854-\$ or US-6194979-\$ or US-6102710-\$).did. or (US-6097097-\$ or US-6023408-\$ or US-6087885-\$ or US-6075211-\$ or US-5978231-\$ or US-5854534-\$ or US-5955752-\$).did. or (US-20020113673-\$ or US-20010010207-\$ or US-20020118075-\$ or US-20020027763-\$ or US-20020101382-\$ or US-20010017556-\$ or US-20010013075-\$ or US-20020020917-\$).did.) and ((shield or shielded or shielding) near10 (plate or conductor or line))) and (hole or via or opening or throughhole or viahole or throughhole or through-hole or via-hole)) and antenna) and (wire or wirebond or wire-bond or wire-bonding or pad)) and (flip near chip)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/27 14:35
	4825	ground adj plate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 15:26
	599	(ground adj plate) and (power near supply)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 15:26
	7	((ground adj plate) and (power near supply)) and ((ground adj plate) near20 (power near supply) near20 (insulating or dielectric or insulator))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 15:29
	0	((ground adj plate) and (power near supply)) and ((ground adj plate) near20 (power near supply) near20 (insulating or dielectric or insulator))) and (line near conductor)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 15:30
	12	(ground near plate) and (ground near potential) and (p wer n ar supply) and (line near c nductor) and (insulating or insulator r di lectric) and capacitance	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 15:34

-	24	(gr und near plat) and (p wer n ar supply) and (lin near conductor) and (insulating or insulat r r dielectric) and capacitanc	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 15:36
-	0	((gr und near plate) and (p wer near supply) and (line near conductor) and (insulating or insulator or dielectric) and capacitance) and ((power near5 supply near5 conductor) near10 (ground near5 plate) near10 (insulating or insulator or dielectric))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 15:38
-	2	((power near5 supply near5 conductor) near10 (ground near5 plate) near10 (insulating or insulator or dielectric))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 15:38
-	478	((power near5 supply) near10 (ground) near10 (insulating or insulator or dielectric))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 15:39
-	8	((power near5 supply) near10 (ground) near10 (insulating or insulator or dielectric))) and (mmic or monolithic)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 15:40
-	6971	(mmic or ((monolithic or monolithical or monolithically) and microwave))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 15:42
-	2869	((mmic or ((monolithic or monolithical or monolithically) and microwave))) and (ground or gnd)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 15:42
-	2051	((mmic or ((monolithic or monolithical or monolithically) and microwave))) and (ground or gnd)) and (power)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 15:42
-	1295	((mmic or ((monolithic or monolithical or monolithically) and microwave))) and (ground or gnd)) and (power)) and (insulating or insulator or dielectric)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 15:43
-	77	((mmic or ((monolithic or monolithical or monolithically) and microwave))) and (gr und or gnd)) and (p w r)) and (insulating or insulator or dielectric)) and (high near5 fr quency n ar5 transmission n ar5 lin)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 15:44

-	493	(((mic or ((monolithic or monolithical or monolithically) and microwave))) and (ground or gnd)) and (power)) and (insulating or insulator or dielectric)) and (transmission near5 line) and (high near5 frequency)) and capacitance	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 15:45
-	298	(((mic or ((monolithic or monolithical or monolithically) and microwave))) and (ground or gnd)) and (power)) and (insulating or insulator or dielectric)) and (transmission near5 line) and (high near5 frequency)) and capacitance	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 15:46
-	0	((((mic or ((monolithic or monolithical or monolithically) and microwave))) and (ground or gnd)) and (power)) and (insulating or insulator or dielectric)) and (transmission near5 line) and (high near5 frequency)) and capacitance) and (ground near30 (insulating or insulator or dielectric) near30 power near30 supply)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 15:47
-	7	((((mic or ((monolithic or monolithical or monolithically) and microwave))) and (ground or gnd)) and (power)) and (insulating or insulator or dielectric)) and (transmission near5 line) and (high near5 frequency)) and capacitance) and (ground near30 (insulating or insulator or dielectric) near30 power)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 15:49
-	2	((((mic or ((monolithic or monolithical or monolithically) and microwave))) and (ground or gnd)) and (power)) and (insulating or insulator or dielectric)) and (transmission near5 line) and (high near5 frequency)) and capacitance) and ((ground near (plate or line)) near30 (insulating or insulator or dielectric) near30 power)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 15:53
-	2541	power near30 (insulating or insulator or dielectric) near30 (gnd or ground or vss)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 15:56
-	203	(power near30 (insulating or insulator or dielectric) near30 (gnd or ground or vss)) and (microwave or mic)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/23 13:54
-	65	((power near30 (insulating or insulator or dielectric) near30 (gnd or ground or vss)) and (microwave or mic)) and capacitance	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 15:56
-	20	((power near30 (insulating or insulator or dielectric) near30 (gnd or ground or vss)) and (microwave or mic)) and capacitance) and (ground near (line or plate))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 15:57

-	12	(((power near30 (insulating or insulator or dielectric) near30 (ground or vss)) and (microwave or mmic)) and capacitance) and (ground near (line or plate))) and (power near (supply or line or plate)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 15:58
-	1472839	(((power near30 (insulating or insulator or dielectric) near30 (ground or vss)) and (microwave or mmic)) and capacitance) and (ground near (line or plate))) and (power near (supply or line or plate))) an substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 15:58
-	11	(((power near30 (insulating or insulator or dielectric) near30 (ground or vss)) and (microwave or mmic)) and capacitance) and (ground near (line or plate))) and (power near (supply or line or plate))) and substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 16:10
-	43322	semiconductor and substrate and (ground near (plate or line)) and (power near (supply or line)) and (insulating or insulator or dielectric) conductor and capacitance	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 16:15
-	3331	(semiconductor and substrate and (ground near (plate or line)) and (power near (supply or line)) and (insulating or insulator or dielectric) conductor and capacitance) and ((line or plate) near conductor)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 16:16
-	839	((semiconductor and substrate and (ground near (plate or line)) and (power near (supply or line)) and (insulating or insulator or dielectric) conductor and capacitance) and ((line or plate) near conductor)) and (transmission near line)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 16:17
-	2	(((semiconductor and substrate and (ground near (plate or line)) and (power near (supply or line)) and (insulating or insulator or dielectric) conductor and capacitance) and ((line or plate) near conductor)) and (transmission near line)) and ((ground near (plate or line)) near30 (power near (supply or line)) near30 (insulating or insulator or dielectric))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/19 16:21
-	69	(((semiconductor and substrate and (ground near (plate or line)) and (power near (supply or line)) and (insulating or insulator or dielectric) conductor and capacitance) and ((line or plate) near conductor)) and (transmission near line)) and (ground near (plate or line)) and (power near (supply or line)) and (insulating or insulator or dielectric))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 10:40
-	9	(substrate near20 ((line or strip or plate) near conductor) near20 (insulating or insulator or dielectric)) and ((ground near (plate or line)) near20 power)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 10:48

-	18	(substrat near20 ((lin or strip r plate) near c nduct r)) and ((gr und n ar (plate or line)) near20 power)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 10:46
-	1006	(substrat n ar20 ((line or strip or plate))) and ((ground near (plate or line)) near20 power)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 10:48
-	1006	(substrate near20 ((line or strip or plate))) and ((ground near (plate or line)) near20 power)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 10:48
-	178	(substrate near20 ((line or strip or plate)) near20 (insulating or insulator or dielectric)) and ((ground near (plate or line)) near20 power)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 10:50
-	96	((substrate near20 ((line or strip or plate)) near20 (insulating or insulator or dielectric)) and ((ground near (plate or line)) near20 power)) and capacitance	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 10:50
-	11	((substrate near20 ((line or strip or plate)) near20 (insulating or insulator or dielectric)) and ((ground near (plate or line)) near20 power)) and capacitance) and (microwave or mcim)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 10:50
-	11	((substrate near20 ((line or strip or plate)) near20 (insulating or insulator or dielectric)) and ((ground near (plate or line)) near20 power)) and capacitance) and (microwave or mmic)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 10:51
-	16	((substrate near20 ((line or strip or plate)) near20 (insulating or insulator or dielectric)) and ((ground near (plate or line)) near20 power)) and capacitance) and (microwave or mmic or monolithic or monolithical or monolithically)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 10:51
-	23	((substrate near20 ((line or strip or plate)) near20 (insulating or insulator or dielectric)) and ((ground near (plate or line)) near20 power)) and capacitance) and (transmission near line)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 10:56
-	2	((substrate near20 ((line or strip or plate)) near20 (insulating or insulator or dielectric)) and ((gr und n ar (plate or line)) near20 p wer)) and capacitance) and (transmission near line)) and (capacitance r capacit r).ti,clm,ab.) and (gr und and pow r).ti,clm,ab.) and (transmissi n).ti,ab,clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 10:57

-	10	(((substrat near20 ((lin or strip r plat)) near20 (insulating or insulat r or dielectric)) and ((gr und n ar (plate r line)) n ar20 pow r)) and capacitance) and (transmission near line)) and (capacitance r capacit r).ti,clm,ab.) and (gr und and power).ti,clm,ab.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 10:58
-	15	(((substrate near20 ((line or strip or plate)) near20 (insulating or insulator or dielectric)) and ((ground near (plate or line)) near20 power)) and capacitance) and (transmission near line)) and (capacitance or capacitor).ti,clm,ab.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:00
-	2	((ground adj (line or plate)) and (power adj (line or supply)) and (line or plate) and substrate and (capacitance or capacitive or capacitor) and (transmission adj line)).ti,clm,ab.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:04
-	13	mimino near yutaka	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:03
-	7	((ground near (line or plate)) and (power near (line or supply)) and (line or plate) and substrate and (capacitance or capacitive or capacitor) and (transmission adj line)).ti,clm,ab.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:06
-	5	(((ground near5 (line or plate)) and (power near5 (line or supply)) and (line or plate) and substrate and (capacitance or capacitive or capacitor) and (transmission adj line)).ti,clm,ab.) and (mmic or microwave or monolithic or monolithical or monolithically)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:08
-	360	(((ground near5 (line or plate)) and (power near5 (line or supply)) and (line or plate) and substrate and (capacitance or capacitive or capacitor) and (transmission adj line))) and (mmic or microwave or monolithic or monolithical or monolithically)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:12
-	61	baba near osamu	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:09
-	12	(baba near osamu) and (mmic or microwave)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:10

-	287	a ki near yoshi	USPAT; US-PGPUB; EPO; JP ; DERWENT; IBM_TDB	2002/09/20 11:10
-	4	(a ki n ar yoshi) and (microwave or mmic)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:11
-	0	gotoh near muneharu	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:11
-	5	(((ground near5 (line or plate)) and (power near5 (line or supply)) and (line or plate) and substrate and (capacitance or capacitive or capacitor) and (transmission adj line))) and (mmic or microwave or monolithic or monolithical or monolithically)) and fujitsu	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:15
-	83539	(strip or line or plate) near5 conductor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:16
-	11185	((strip or line or plate) near5 conductor) and ((ground or gnd or vss) near5 (plate or strip or line))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:17
-	4879	(((strip or line or plate) near5 conductor) and ((ground or gnd or vss) near5 (plate or strip or line))) and (power near5 (supply or plate or strip or line))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:18
-	1135	(((strip or line or plate) near5 conductor) and ((ground or gnd or vss) near5 (plate or strip or line))) and (power near5 (supply or plate or strip or line))) and (insulating or insulator or dielectric) and substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:19
-	412	((((strip or line or plate) near5 conductor) and ((ground or gnd or vss) near5 (plate or strip or line))) and (power near5 (supply or plate or strip or line))) and (insulating or insulator or dielectric) and substrate) and (mmic or microwave or monolithic)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:20
-	297	((((strip or line or plate) near5 conductor) and ((ground or gnd or vss) near5 (plate or strip or line))) and (power near5 (supply or plate or strip or line))) and (insulating or insulator or dielectric) and substrate) and (mmic or microwave or monolithic)) and (transmission near5 conductor)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:20

-	195	(((((((strip or line or plate) near5 conductor) and ((ground or gnd or vss) near5 (plate or strip or line)))) and (power near5 (supply or plate or strip or line))) and (insulating or insulator or dielectric) and substrate) and (mmic or microwave or monolithic)) and (transmission near line)) and (capacitance or capacitive or capacitor)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:20
-	69	(((((((strip or line or plate) near5 conductor) and ((ground or gnd or vss) near5 (plate or strip or line)))) and (power near5 (supply or plate or strip or line))) and (insulating or insulator or dielectric) and substrate) and (mmic or microwave or monolithic)) and (transmission near line)) and (capacitance or capacitive or capacitor)) and ((power or vdd) near30 (ground or gnd or vss))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:22
-	14	(((((((strip or line or plate) near5 conductor) and ((ground or gnd or vss) near5 (plate or strip or line)))) and (power near5 (supply or plate or strip or line))) and (insulating or insulator or dielectric) and substrate) and (mmic or microwave or monolithic)) and (transmission near line)) and (capacitance or capacitive or capacitor)) and ((power or vdd) near30 (ground or gnd or vss) near30 (insulating or insulator or dielectric))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:22
-	50	(((((((strip or line or plate) near5 conductor) and ((ground or gnd or vss) near5 (plate or strip or line)))) and (power near5 (supply or plate or strip or line))) and (insulating or insulator or dielectric) and substrate) and (mmic or microwave or monolithic)) and (transmission near line)) and (capacitance or capacitive or capacitor)) and ((power or vdd) near30 (ground or gnd or vss)) and (substrate near30 (line or plate or strip))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:24
-	1317	substrate and ((ground near (plate or line or strip)) near30 (power near (supply or line or strip or plate)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:26
-	765	(substrate and ((ground near (plate or line or strip)) near30 (power near (supply or line or strip or plate)))) and (substrate near30 (line or plate or strip))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:27
-	119	((substrate and ((ground near (plate or line or strip)) near30 (power near (supply or line or strip or plate)))) and (substrate near30 (line or plate or strip))) and (transmission adjacent line)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/23 13:57

-	109	(((substrate and ((ground near (plate or line or strip)) near30 (power near (supply or line or strip or plate)))) and (substrate near30 (line or plate or strip))) and (transmission adjacent line)) and (capacitor or capacitance or capacitive)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 12:21
-	84	(((substrate and ((ground near (plate or line or strip)) near30 (power near (supply or line or strip or plate)))) and (substrate near30 (line or plate or strip))) and (transmission adjacent line)) and (capacitor or capacitance or capacitive)) and (insulating or insulator or dielectric)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:28
-	22	(((substrate and ((ground near (plate or line or strip)) near30 (power near (supply or line or strip or plate)))) and (substrate near30 (line or plate or strip))) and (transmission adjacent line)) and (capacitor or capacitance or capacitive)) and (insulating or insulator or dielectric)) and ((insulating or insulator or dielectric) near30 (ground or power))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:29
-	31	(US-5384486-\$ or US-6272003-\$ or US-6121854-\$ or US-6023408-\$ or US-5027253-\$ or US-5025233-\$ or US-4801996-\$ or US-4739448-\$ or US-4342013-\$ or US-6075211-\$ or US-5177670-\$ or US-4866507-\$ or US-4371851-\$ or US-4153988-\$ or US-6194979-\$ or US-6102710-\$ or US-6087885-\$ or US-5854534-\$ or US-5955752-\$ or US-5287072-\$ or US-6097097-\$ or US-5978231-\$ or US-5519176-\$ or US-5402318-\$ or US-5272600-\$).did. or (US-20020118075-\$ or US-20020027763-\$ or US-20020101382-\$ or US-20010013075-\$ or US-20020020917-\$ or US-20010017556-\$).did.	USPAT; US-PGPUB	2002/09/20 11:31

-	17	((US-5384486-\$ or US-6272003-\$ or US-6121854-\$ or US-6023408-\$ r US-5027253-\$ or US-5025233-\$ r US-4801996-\$ or US-4739448-\$ r US-4342013-\$ or US-6075211-\$ r US-5177670-\$ or US-4866507-\$ r US-4371851-\$ or US-4153988-\$ or US-6194979-\$ or US-6102710-\$ or US-6087885-\$ or US-5854534-\$ or US-5955752-\$ or US-5287072-\$ or US-6097097-\$ or US-5978231-\$ or US-5519176-\$ or US-5402318-\$ or US-5272600-\$).did. or (US-20020118075-\$ or US-20020027763-\$ or US-20020101382-\$ or US-20010013075-\$ or US-20020020917-\$ or US-20010017556-\$).did.) and (mmic or microwave or monolithic or monolithical or monolithically)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:34
-	29	((US-5384486-\$ or US-6272003-\$ or US-6121854-\$ or US-6023408-\$ or US-5027253-\$ or US-5025233-\$ or US-4801996-\$ or US-4739448-\$ or US-4342013-\$ or US-6075211-\$ or US-5177670-\$ or US-4866507-\$ or US-4371851-\$ or US-4153988-\$ or US-6194979-\$ or US-6102710-\$ or US-6087885-\$ or US-5854534-\$ or US-5955752-\$ or US-5287072-\$ or US-6097097-\$ or US-5978231-\$ or US-5519176-\$ or US-5402318-\$ or US-5272600-\$).did. or (US-20020118075-\$ or US-20020027763-\$ or US-20020101382-\$ or US-20010013075-\$ or US-20020020917-\$ or US-20010017556-\$).did.) and (capacitor or capacitance)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:34
-	26	(((US-5384486-\$ or US-6272003-\$ or US-6121854-\$ or US-6023408-\$ or US-5027253-\$ or US-5025233-\$ or US-4801996-\$ or US-4739448-\$ or US-4342013-\$ or US-6075211-\$ or US-5177670-\$ or US-4866507-\$ or US-4371851-\$ or US-4153988-\$ or US-6194979-\$ or US-6102710-\$ or US-6087885-\$ or US-5854534-\$ or US-5955752-\$ or US-5287072-\$ or US-6097097-\$ or US-5978231-\$ or US-5519176-\$ or US-5402318-\$ or US-5272600-\$).did. or (US-20020118075-\$ or US-20020027763-\$ or US-20020101382-\$ r US-20010013075-\$ or US-20020020917-\$ r US-20010017556-\$).did.) and (capacitor or capacitance)) and (transmissi n)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:35

-	26	(((US-5384486-\$ or US-6272003-\$ or US-6121854-\$ or US-6023408-\$ or US-5027253-\$ r US-5025233-\$ or US-4801996-\$ r US-4739448-\$ or US-4342013-\$ r US-6075211-\$ r US-5177670-\$ or US-4866507-\$ or US-4371851-\$ or US-4153988-\$ or US-6194979-\$ or US-6102710-\$ or US-6087885-\$ or US-5854534-\$ or US-5955752-\$ or US-5287072-\$ or US-6097097-\$ or US-5978231-\$ or US-5519176-\$ or US-5402318-\$ or US-5272600-\$).did. or (US-20020118075-\$ or US-20020027763-\$ or US-20020101382-\$ or US-20010013075-\$ or US-20020020917-\$ or US-20010017556-\$).did.) and (capacitor or capacitance)) and (transmission near line)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:39
-	17	(((US-5384486-\$ or US-6272003-\$ or US-6121854-\$ or US-6023408-\$ or US-5027253-\$ or US-5025233-\$ or US-4801996-\$ or US-4739448-\$ or US-4342013-\$ or US-6075211-\$ or US-5177670-\$ or US-4866507-\$ or US-4371851-\$ or US-4153988-\$ or US-6194979-\$ or US-6102710-\$ or US-6087885-\$ or US-5854534-\$ or US-5955752-\$ or US-5287072-\$ or US-6097097-\$ or US-5978231-\$ or US-5519176-\$ or US-5402318-\$ or US-5272600-\$).did. or (US-20020118075-\$ or US-20020027763-\$ or US-20020101382-\$ or US-20010013075-\$ or US-20020020917-\$ or US-20010017556-\$).did.) and (capacitor or capacitance)) and (transmission near line)) and (ground near30 power near30 (insulating or insulator or dielectric))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 11:40

	17	<p> ((((US-5384486-\$ r US-6272003-\$ or US-6121854-\$ or US-6023408-\$ r US-5027253-\$ r US-5025233-\$ or US-4801996-\$ r US-4739448-\$ or US-4342013-\$ or US-6075211-\$ or US-5177670-\$ or US-4866507-\$ or US-4371851-\$ or US-4153988-\$ or US-6194979-\$ or US-6102710-\$ or US-6087885-\$ or US-5854534-\$ or US-5955752-\$ or US-5287072-\$ or US-6097097-\$ or US-5978231-\$ or US-5519176-\$ or US-5402318-\$ or US-5272600-\$).did. or (US-20020118075-\$ or US-20020027763-\$ or US-20020101382-\$ or US-20010013075-\$ or US-20020020917-\$ or US-20010017556-\$).did.) and (capacitor or capacitance)) and (transmission near line)) and (ground near30 power near30 (insulating or insulator or dielectric))) and (line or plate or strip) near30 substrate </p>	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 12:17
	4	<p> ((((US-5384486-\$ or US-6272003-\$ or US-6121854-\$ or US-6023408-\$ or US-5027253-\$ or US-5025233-\$ or US-4801996-\$ or US-4739448-\$ or US-4342013-\$ or US-6075211-\$ or US-5177670-\$ or US-4866507-\$ or US-4371851-\$ or US-4153988-\$ or US-6194979-\$ or US-6102710-\$ or US-6087885-\$ or US-5854534-\$ or US-5955752-\$ or US-5287072-\$ or US-6097097-\$ or US-5978231-\$ or US-5519176-\$ or US-5402318-\$ or US-5272600-\$).did. or (US-20020118075-\$ or US-20020027763-\$ or US-20020101382-\$ or US-20010013075-\$ or US-20020020917-\$ or US-20010017556-\$).did.) and (capacitor or capacitance)) and (transmission near line)) and (ground near30 power near30 (insulating or insulator or dielectric))) and (line or plate or strip) near30 substrate) and capacitance.clm. </p>	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 12:18

-	9	((US-5384486-\$ or US-6272003-\$ or US-6121854-\$ r US-6023408-\$ or US-5027253-\$ r US-5025233-\$ or US-4801996-\$ r US-4739448-\$ r US-4342013-\$ r US-6075211-\$ r US-5177670-\$ r US-4866507-\$ or US-4371851-\$ or US-4153988-\$ or US-6194979-\$ or US-6102710-\$ or US-6087885-\$ or US-5854534-\$ or US-5955752-\$ or US-5287072-\$ or US-6097097-\$ or US-5978231-\$ or US-5519176-\$ or US-5402318-\$ or US-5272600-\$).did. or (US-20020118075-\$ or US-20020027763-\$ or US-20020101382-\$ or US-20010013075-\$ or US-20020020917-\$ or US-20010017556-\$).did.) and capacitance.clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 12:18
-	0	((US-5384486-\$ or US-6272003-\$ or US-6121854-\$ or US-6023408-\$ or US-5027253-\$ or US-5025233-\$ or US-4801996-\$ or US-4739448-\$ or US-4342013-\$ or US-6075211-\$ or US-5177670-\$ or US-4866507-\$ or US-4371851-\$ or US-4153988-\$ or US-6194979-\$ or US-6102710-\$ or US-6087885-\$ or US-5854534-\$ or US-5955752-\$ or US-5287072-\$ or US-6097097-\$ or US-5978231-\$ or US-5519176-\$ or US-5402318-\$ or US-5272600-\$).did. or (US-20020118075-\$ or US-20020027763-\$ or US-20020101382-\$ or US-20010013075-\$ or US-20020020917-\$ or US-20010017556-\$).did.) and capacitance.clm.) and (capacitance near10 (higher or lower)).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 12:19
-	4	((US-5384486-\$ or US-6272003-\$ or US-6121854-\$ or US-6023408-\$ or US-5027253-\$ or US-5025233-\$ or US-4801996-\$ or US-4739448-\$ or US-4342013-\$ or US-6075211-\$ or US-5177670-\$ or US-4866507-\$ or US-4371851-\$ or US-4153988-\$ or US-6194979-\$ or US-6102710-\$ or US-6087885-\$ or US-5854534-\$ or US-5955752-\$ or US-5287072-\$ or US-6097097-\$ or US-5978231-\$ or US-5519176-\$ or US-5402318-\$ or US-5272600-\$).did. or (US-20020118075-\$ or US-20020027763-\$ r US-20020101382-\$ r US-20010013075-\$ or US-20020020917-\$ or US-20010017556-\$).did.) and capacitance.clm.) and (capacitance near10 (higher or lower)).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 12:19

-	9	(((substrate and ((ground near (plate or line or strip)) near30 (power near (supply or line or strip or plate)))) and (substrate near30 (line or plate or strip))) and (transmission adjacent line)) and (capacitor or capacitance or capacitor)) and (capacitance near10 (higher or lower)) and (dielectric adjacent constant)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 12:25
-	19	(((strip or line or plate) near5 conductor) and ((ground or gnd or vss) near5 (plate or strip or line))) and (power near5 (supply or plate or strip or line))) and (insulating or insulator or dielectric) and substrate) and (line near conductor) and (dielectric near constant) and (capacitance near10 (higher or lower))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 12:27
-	1	((US-5384486-\$ or US-6272003-\$ or US-6121854-\$ or US-6023408-\$ or US-5027253-\$ or US-5025233-\$ or US-4801996-\$ or US-4739448-\$ or US-4342013-\$ or US-6075211-\$ or US-5177670-\$ or US-4866507-\$ or US-4371851-\$ or US-4153988-\$ or US-6194979-\$ or US-6102710-\$ or US-6087885-\$ or US-5854534-\$ or US-5955752-\$ or US-5287072-\$ or US-6097097-\$ or US-5978231-\$ or US-5519176-\$ or US-5402318-\$ or US-5272600-\$).did. or (US-20020118075-\$ or US-20020027763-\$ or US-20020101382-\$ or US-20010013075-\$ or US-20020020917-\$ or US-20010017556-\$).did.) and (capacitance near30 conductor near30 (higher or lower))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 12:41
-	565	(capacitance near30 conductor near30 (higher or lower))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 12:42
-	81	((capacitance near30 conductor near30 (higher or lower))) and (mmic or microwave or monolithic)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 12:43
-	19	(((capacitance near30 conductor near30 (higher or lower))) and (mmic or microwave or monolithic)) and (ground and power and (insulating or insulator or dielectric) and substrate and (strip or line or plate))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/20 12:44

-	33	(US-6194979-\$ or US-6121854-\$ r US-5384486-\$ or US-4801996-\$ r US-4371851-\$ or US-4342013-\$ r US-6102710-\$ or US-6075211-\$ or US-6087885-\$ or US-5854534-\$ r US-5177670-\$ or US-5402318-\$ r US-4866507-\$ or US-4153988-\$ or US-5287072-\$ or US-5955752-\$ or US-6097097-\$ or US-5027253-\$ or US-5025233-\$ or US-4739448-\$ or US-5978231-\$ or US-5519176-\$ or US-5272600-\$ or US-6272003-\$ or US-6023408-\$ or US-5354599-\$).did. or (US-5396397-\$).did. or (US-20020118075-\$ or US-20020101382-\$ or US-20010013075-\$ or US-20020020917-\$ or US-20010017556-\$ or US-20020027763-\$).did.	USPAT; US-PGPUB	2002/09/23 13:51
-	0	((US-6194979-\$ or US-6121854-\$ or US-5384486-\$ or US-4801996-\$ or US-4371851-\$ or US-4342013-\$ or US-6102710-\$ or US-6075211-\$ or US-6087885-\$ or US-5854534-\$ or US-5177670-\$ or US-5402318-\$ or US-4866507-\$ or US-4153988-\$ or US-5287072-\$ or US-5955752-\$ or US-6097097-\$ or US-5027253-\$ or US-5025233-\$ or US-4739448-\$ or US-5978231-\$ or US-5519176-\$ or US-5272600-\$ or US-6272003-\$ or US-6023408-\$ or US-5354599-\$).did. or (US-5396397-\$).did. or (US-20020118075-\$ or US-20020101382-\$ or US-20010013075-\$ or US-20020020917-\$ or US-20010017556-\$ or US-20020027763-\$).did.) and shield) and shield near plate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/23 13:52
-	6	((US-6194979-\$ or US-6121854-\$ or US-5384486-\$ or US-4801996-\$ or US-4371851-\$ or US-4342013-\$ or US-6102710-\$ or US-6075211-\$ or US-6087885-\$ or US-5854534-\$ or US-5177670-\$ or US-5402318-\$ or US-4866507-\$ or US-4153988-\$ or US-5287072-\$ or US-5955752-\$ or US-6097097-\$ or US-5027253-\$ or US-5025233-\$ or US-4739448-\$ or US-5978231-\$ or US-5519176-\$ or US-5272600-\$ or US-6272003-\$ or US-6023408-\$ or US-5354599-\$).did. or (US-5396397-\$).did. or (US-20020118075-\$ or US-20020101382-\$ r US-20010013075-\$ or US-20020020917-\$ r US-20010017556-\$ or US-20020027763-\$).did.) and shield	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/23 13:52

-	34	(power near30 (insulating or insulator or dielectric) near30 (ground or vss)) and (microwave or mmic) and shield	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/23 13:55
-	14	((substrate and ((ground near (plate or line or strip)) near30 (power near (supply or line or strip or plate)))) and (substrate near30 (line or plate or strip))) and (transmission adjacent line) and shield	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/23 13:59
-	34	(ground near (plate or strip or line)) and (insulating or insulator or dielectric) and (conductor near (line or plate or strip)) and (shield near (plate or strip or line))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/23 14:02
-	5	(ground near (plate or strip or line)) and (insulating or insulator or dielectric) and (conductor near (line or plate or strip)) and (shield near (plate or strip or line)) and (mmic or microwave)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/23 14:04
-	14	(ground near (plate or strip or line)) and (insulating or insulator or dielectric) and (shield near (plate or strip or line)) and (mmic or microwave)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/23 14:05
-	137	(ground near (plate or strip or line)) and (insulating or insulator or dielectric) and ((shield or shielding) near5 (plate or strip or line)) and (mmic or microwave)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/23 14:06
-	104	((ground near (plate or strip or line)) and (insulating or insulator or dielectric) and ((shield or shielding) near5 (plate or strip or line)) and (mmic or microwave)) and substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/23 14:07
-	40	((((ground near (plate or strip or line)) and (insulating or insulator or dielectric) and ((shield or shielding) near5 (plate or strip or line)) and (mmic or microwave)) and substrate) and (via or hole or opening)) and (bond or bonding or bonded)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/23 14:08
-	90	((((ground near (plate or strip or line)) and (insulating or insulator or dielectric) and ((shield or shielding) near5 (plate or strip or line)) and (mmic or microwave)) and substrate) and (via or hole or opening)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/23 14:14
-	38	((((ground near (plate or strip or line)) and (insulating or insulator or dielectric) and ((shield or shielding) near5 (plate or strip or line)) and (mmic or microwave)) and substrate) and (via or hole or opening)) and waveguide	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/23 14:29

-	24100	(grounding or gnd) adj (plate or line or strip)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/23 14:39
-	7749	((ground or grounding) adj (plate or line or strip)) and (insulating or insulator or dielectric)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/23 14:31
-	9	((((ground or grounding or gnd) adj (plate or line or strip)) and (insulating or insulator or dielectric)) and ((shield or shielding) adj (plate or line or strip))) and substrate and (bond or bonding or bonded) and pad	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/23 14:32
-	35	((((ground or grounding or gnd) adj (plate or line or strip)) and (insulating or insulator or dielectric)) and ((shield or shielding) adj (plate or line or strip))) and substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/23 14:33
-	74	((((ground or grounding or gnd) adj (plate or line or strip)) and (insulating or insulator or dielectric)) and ((shield or shielding) adj (plate or line or strip)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/23 14:37
-	3	((((ground or grounding or gnd) adj (plate or line or strip)) and (insulating or insulator or dielectric)) and ((shield or shielding) adj (plate or line or strip))) and waveguide	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/23 14:38
-	203	((((ground or grounding or gnd) adj (plate or line or strip)) and (insulating or insulator or dielectric)) and ((shield or shielding) adj (plate or line or strip)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/23 14:37
-	5	((((ground or grounding or gnd) adj (plate or line or strip)) and (insulating or insulator or dielectric)) and ((shield or shielding) adj (plate or line or strip))) and waveguide	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/23 14:38
-	20	(ground or grounding or gnd) near (plate or line or strip) and (insulating or insulator or dielectric) and ((shield or shielding) near (plate or strip or line)) and waveguide	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/23 14:44
-	117	(ground or grounding or gnd) near5 (plate or line or strip) and (insulating or insulator or dielectric) and ((shield or shielding) near5 (plate or strip or line)) and waveguide and substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/23 14:45

-	105	((ground or grounding r gnd) n ar5 (plate r line or strip) and (insulating r insulat r or di lectric) and ((shield or shi lding) near5 (plat r strip r lin)) and waveguid and substrat) and (via or pening r hol)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/23 14:46
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